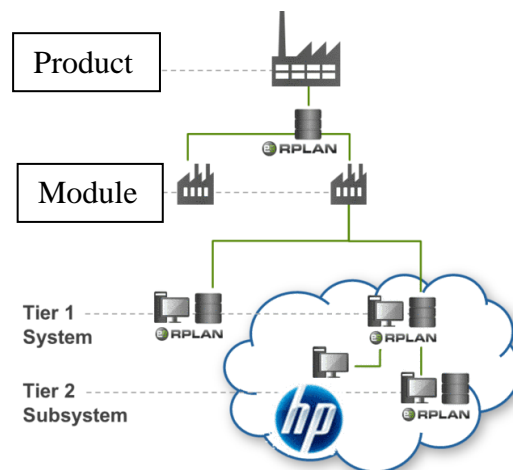


**Press Release**

**ACTANO moves its RPLAN e3 collaborative project management software into the cloud with Hewlett-Packard as its preferred infrastructure partner for market implementation**

*The new cloud solution is designed primarily to enable manufacturers and suppliers to rapidly launch international and cross-enterprise development partnerships.*

**Munich, 1 December 2011 – Technology mergers between manufacturers, increasing integration of suppliers in development projects, and higher productivity targets all call for the swift establishment of stable and homogeneous development environments. As one of the very first providers, ACTANO has taken account of the growing need to plan and control complex product development processes and is moving RPLAN e3 into the high availability cloud environment. In this field, ACTANO is working with Hewlett-Packard as a preferred infrastructure partner for market implementation. The common goal of the two companies is to deliver custom cloud solutions that facilitate collaborative project integration between globally distributed manufacturers and suppliers.**



*The integration of development partners via RPLAN e3 as a cloud solution supports end-to-end project management throughout the entire value added network.*

Michael Laurim, Managing Director at ACTANO, explains: "Thanks to new technologies, the number of joint ventures and partnerships will continue to grow not only in the automotive sector. We see Hewlett-Packard as an ideal innovation and infrastructure partner to help build international project management environments with much lower barriers to entry. The collaborative RPLAN e3 methodology, end-to-end cross company project management, and cloud-based value added networks represent a solid platform – not only to support partnerships between manufacturers but also to effectively integrate suppliers."

Oliver Bahns, Automotive and Aerospace Director at Hewlett-Packard, confirms this view. "The partnership with ACTANO is set to deliver a cloud-based project management solution that fully satisfies the needs of distributed product development and the associated integration of external partners along the value added chain. Working hand in hand with ACTANO, we are in a position to implement a cloud solution for project management and for the ecosystem of an OEM in which all participants have secure access to the RPLAN e3 software."

#### **ACTANO GmbH**

Companies in the discrete manufacturing industry deploy the RPLAN software and employ ACTANO's implementation consulting services to develop complex products. RPLAN e3 integrates national and international suppliers in end-to-end value chains to ensure highly efficient product development processes. Currently, more than 100 high-profile companies with more than 120,000 users worldwide use RPLAN and RPLAN e3 to master challenges such as globalization and heterogeneity, integration of non-industrial partners, and synchronization and interaction in dynamic processes. Customers include Airbus, Allgaier Werke, Audi, BMW, Daimler, MTU Aero Engines, VW, and many more. ACTANO has entered into partnerships with leading solution providers, engineering providers, and IT infrastructure providers such as Siemens PLM, PTC, MHP, and Hewlett-Packard. The company has its head office in Munich and subsidiaries in Stuttgart, Wolfsburg, and Detroit/USA.

Further information is available at [www.ACTANO.de](http://www.ACTANO.de)

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